

| Title of Change: | Dual source AR0144 for Assembly and Final Test at ASE (Advanced Semiconductor Engineering) Malaysia. | | | | |
|---|--|--|--|--|--|
| Proposed Changed Material First Ship Date: | 01 Sep 2023 or earlier if approved by customer | | | | |
| Current Material Last Order Date: | N/A Orders received after the Current Material Last Order Date expiration are to be considered as orders for new changed material as described in this PCN. Orders for current (unchanged) material after this date will be per mutual agreement and current material inventory availability. | | | | |
| Current Material Last Delivery Date: | N/A The Current Material Last Delivery Date may be subject to change based on build and depletion of the current (unchanged) material inventory | | | | |
| Product Category: | Active components – Integrated circuits | | | | |
| Contact information: | Contact your local onsemi Sales Office or Mike.Webster@onsemi.com | | | | |
| PCN Samples Contact: | Contact your local onsemi Sales Office to place sample order. Sample requests are to be submitted no later than 45 days after publication of this change notification. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements. | | | | |
| Sample Availability Date: | 20 Mar 2023 | | | | |
| PPAP Availability Date: | 27 Feb 2023 | | | | |
| Additional Reliability Data: | Contact your local onsemi Sales Office or <u>Amy.Wu@onsemi.com</u> | | | | |
| Type of Notification: | This is a Final Product/Process Change Notification (FPCN) sent to customers. The change will be implemented at 'Proposed Change Material First Ship Date' in compliance to J-STD-46 or ZVEI, or earlier upon customer approval, or per our signed agreements. onsemi will consider this proposed change and it's conditions acceptable, unless an inquiry is made in writing within 45 days of delivery of this notice. To do so, contact PCN.Support@onsemi.com. | | | | |
| Change Category | | | | | |
| Category | Type of Change | | | | |
| Test Flow | Move of all or part of electrical wafer test and/or final test to a different location/site/subcontractor | | | | |
| Equipment | Production from a new equipment/tool which uses the same basic technology (replacement | | | | |

Description and Purpose:

Process - Assembly

ASEM (Advanced Semicondutor Engineering Malaysia) is being qualified and added as an additional site for Assembly and Final test for AR0144 packages.

Change of direct material supplier

equipment or extension of existing equipment pool) without change of process. Move of all or part of assembly to a different location/site/subcontractor.,

This is being done to add capacity and mitigate supply chain risks.

The assembly equipment between the sites are equivalent and have been proven on other dual-sourced automotive products.

ASEM will use a different substrate supplier than Kingpak but substrate design is exactly the same.

Product assembled at Tong Hsing (Kingpak) and ASEM can final test at any of the qualified Final Test sites.

There is no change in the test platform, program or limits between the two sites.



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| There is no o | change to form, fit or funct | on of the p | product. | | | | | | | |
|--|--|-------------|--------------------|--|---|---|-------------------------------|--|--|--|
| | | | F | rom | То | | | | | |
| Assembly Site | | Tong Hsing | | Tong Hsing & ASE Malaysia | | | | | | |
| Final Test Site | | | Tong H | sing, KYEC | Tong Hsing, KYEC & ASE Malaysia | | | | | |
| Deckage Substrate | | | Supplier - Festern | | Supplier = E | astern (at Tong | Hsing) | | | |
| | Package Substrate | | Supplie | r = Eastern | Supplie | r = SCC (at ASEI | M) | | | |
| There is no p | product marking change as | a result of | this change | | | | | | | |
| Reason / N | Notivation for Change: | Capacity | improvement | | | | | | | |
| Anticipated impact on fit, form, function, reliability, product safety or manufacturability: No anticipated impacts | | | | | | Specification. dentified, but and excluded. | The device has due to testing | | | |
| Sites Affect | ted: | | | | | | | | | |
| onsemi Site | es | | | External Foundry/Sub | con Sites | | | | | |
| None | | | | ASEM, Malaysia | | | | | | |
| Marking of Change: | Marking of Parts/ Traceability of Change: | | | | | | | | | |
| Reliability | Data Summary: NAME : AR0144AT | | | | | | | | | |
| RMS: n/a fo | r ISG (external qual) | | | | | | | | | |
| Test | Specification | | | Condition | | Interval | Roculte | | | |
| | | | Ta= 1 | 05 °C Ti 100 % max rated | Vice | 1008 brs | | | | |
| FLER | AEC 0100-008 | | 101 | Ta= 125 °C | <u>125</u> °C 24 hrs | | | | | |
| PC | I-STD-020 JESD-01 | 13 | | MSL 3 @ 260 °C | Pass | | | | | |
| нтсі | IFSD22-4103 | 15 | | Ta= 150 °C | = 150 °C 500 hrs | | | | | |
| тс | IESD22-A104 | | | $T_{a=} -55 \degree C t_{0} + 125 \degree C$ | $= -55 ^{\circ}{\rm C}$ to $\pm 125 ^{\circ}{\rm C}$ 1000 ovc 0/2 | | | | | |
| наят | JESD22 A104 | | | 130°C 85% RH with hiss | b hiss 264 hrs 0/2 | | | | | |
| | ST JESD22-AIIU | | | 130°C, 85% RH, unbiased | 6 RH unbiased 264 brs 0/231 | | | | | |
| unasi | AEC 0100-001 | | | | | 2041113 | 0/231 | | | |
| WBS | AEC Q100 001 | | CPK >1.67 Pass | | | | | | | |
| | MIL-STD883 Method | 2011 | 1 | | | | | | | |
| WBP AFC 0003 | | | СРК >: | 1.67, 0 Fails after TC (test #A4) | | | Pass | | | |
| НВМ | HBM AFC 0100-002 | | | 0 Fails; 2KV HBM Pa | | | | | | |
| CDM | AEC Q100-011 | | 0 Fails: 750 | / for corner pins. 500V all o | V all other pins Pass | | | | | |
| LU | AEC Q100-004 | | | 0 Fails | • | | Pass | | | |
| ED | AEC Q100-009 | | Elect. | Distribution: (Test @ C/ R | / H) | | Pass | | | |
| | AEC Q003 | | | | | | | | | |

Note: AEC-1pager is attached.

To view attachments:

1. Download pdf copy of the PCN to your computer

2. Open the downloaded pdf copy of the PCN

3. Click on the paper clip icon available on the menu provided in the left/bottom portion of the screen to reveal the Attachment field

4. Then click on the attached file.



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Electrical Characteristics Summary:

| AR0144 test data at Ta=room temp | | | Lipito | Upper | Tong Hsing | | ASEM | | A | Temp Condition | | | |
|----------------------------------|----------|----------|----------|----------|---------------|--------|----------|--------|--------|----------------|--------|------------|------------------|
| Quantity | Mode | LOL (RI) | 03L (RI) | Units | Specification | Stdev | Mean | CPK | Stdev | Mean | CPK | Accuracy % | of specification |
| D6_PIX_BRT | Dark | 0 | 80 | Pixels | 80 | 1.697 | 1.867 | n/a | 1.800 | 2.000 | n/a | 7.143 | Tj=60 |
| M6_PIX_BRT | Midlight | 0 | 79 | Pixels | 79 | 0.461 | 0.167 | n/a | 0.434 | 0.133 | n/a | 20.000 | Tj=60 |
| M7_PIX_DRK | Midlight | 0 | 79 | Pixels | 79 | 0.610 | 0.200 | n/a | 0.484 | 0.200 | n/a | 0.000 | Tj=60 |
| M3_CLUS_BRT | Midlight | 0 | 9 | Clusters | 9 | 0.000 | 0.000 | n/a | 0.000 | 0.000 | n/a | 0.000 | Tj=60 |
| M4_CLUS_DRK | Midlight | 0 | 9 | Clusters | 9 | 0.000 | 0.000 | n/a | 0.000 | 0.000 | n/a | 0.000 | Tj=60 |
| la_OPER_VAA | Short | 45 | 72 | mA | 72 | 1.527 | 59.467 | 2.735 | 1.581 | 59.547 | 2.625 | 0.135 | Tj=60 |
| Ip_OPER_VAA_PIX | Short | 1 | 50 | mA | 50 | 0.196 | 9.199 | 13.974 | 0.200 | 9.202 | 13.661 | 0.031 | Tj=60 |
| Id_OPER_VDD | Short | 90 | 120 | mA | 120 | 1.404 | 107.696 | 2.922 | 1.220 | 110.376 | 2.630 | 2.488 | Tj=60 |
| Ii_OPER_VDD_PLL | Short | 1 | 50 | mA | 50 | 0.063 | 6.838 | 30.889 | 0.086 | 6.892 | 22.948 | 0.788 | Tj=60 |
| Mh_PVAL_MEAN | Midlight | 1800 | 2600 | code | 2600 | 41.660 | 2147.635 | 2.782 | 38.395 | 2187.172 | 3.361 | 1.841 | Tj=60 |
| Dh_PVAL_MEAN | Dark | 150 | 180 | code | 180 | 2.104 | 166.729 | 2.103 | 0.907 | 166.772 | 4.863 | 0.026 | Tj=60 |

Electrical characteristics are not impacted.

List of Affected Parts:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the <u>PCN Customized Portal</u>.

| Current Part Number | New Part Number | Qualification Vehicle |
|---------------------------|-----------------|------------------------|
| AR0144ATSM20XUEA0-SP-TPBR | NA | AR0144ATSM20XUEA0-DRBR |
| AR0144ATSM20XUEA0-TRBR | NA | AR0144ATSM20XUEA0-DRBR |
| AR0144ATSM20XUEA0-TPBR | NA | AR0144ATSM20XUEA0-DRBR |
| AR0144ATSM20XUEA0-DPBR | NA | AR0144ATSM20XUEA0-DRBR |
| AR0144ATSM20XUEA0-DRBR | NA | AR0144ATSM20XUEA0-DRBR |

Appendix A: Changed Products

DIKG: DIGI-KEY

| Product | Customer Part Number | Qualification Vehicle | New Part Number | Replacement Supplier |
|------------------------|----------------------|------------------------|-----------------|----------------------|
| AR0144ATSM20XUEA0-DPBR | | AR0144ATSM20XUEA0-DRBR | NA | |
| AR0144ATSM20XUEA0-DRBR | | AR0144ATSM20XUEA0-DRBR | NA | |